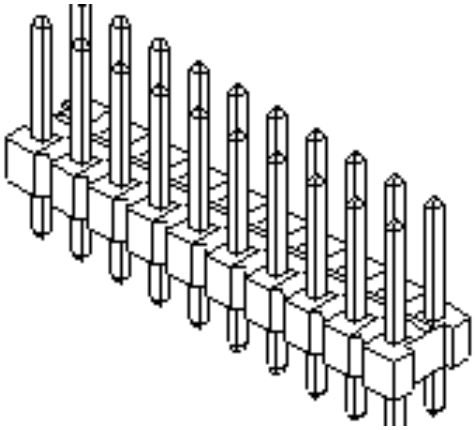
Part Number : 10897282
Product Description : 2.54mm Pitch C-Grid Breakaway Header, Dual Row, Vertical, High Temperature, 28 Circuits, 0.38µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating, 2.72mm PC Tail
Series Number : 70280
Status : Active
Product Category : PCB Headers and Receptacles
Engineering Number : A-70280-0054



Documents & Resources

Drawings
010897282_sd.pdf
PK-70873-0353-001.pdf

3D Models and Design Files
010897282_stp.zip

Specifications
PS-70280-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)6225-DC (07 Nov 2024)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements
- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	70280
Description	2.54mm Pitch C-Grid Breakaway Header, Dual Row, Vertical, High Temperature, 28 Circuits, 0.38µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating, 2.72mm PC Tail
Application	Board-to-Board, Signal, Wire-to-Board
Component Type	PCB Header
Product Name	C-Grid
UPC	800755021851

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	3.0A
Voltage - Maximum	250V

Physical

Breakaway	Yes
Circuits (Loaded)	28
Circuits (maximum)	28
Color - Resin	Black
Durability (mating cycles max)	50

First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	None
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	2.109/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Bag
PC Tail Length	2.79mm
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	2.54mm
Plating min - Mating	0.381µm
Plating min - Termination	2.032µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	No
Stackable	Yes
Temperature Range - Operating	-40° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Lead-Free Process Capability	SMC&WAVE
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
C-Grid Right-Angle, Dual Row, Surface Mount PCB Receptacles	71979
C-Grid Vertical, Dual Row, High Profile, Surface Mount PCB Connectors	71395
C-Grid Vertical, Dual Row, High Profile, Through Hole PCB Receptacles	71850
2.54mm Pitch C-Grid Shunt Terminal Housings	7859